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(12) **United States Design Patent** (10) **Patent No.:** **US D938,373 S**
Schaller et al. (45) **Date of Patent:** **** Dec. 14, 2021**

(54) **SUBSTRATE TRANSFER STRUCTURE**

(56)

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(57)

CLAIM

We claim the ornamental design for a substrate transfer structure, substantially as shown and described.

(**) Term: **15 Years**

DESCRIPTION

(21) Appl. No.: **29/710,816**

(22) Filed: **Oct. 25, 2019**

(51) **LOC (13) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/182**

(58) **Field of Classification Search**

USPC D13/101, 118, 120, 121, 133, 182, 184,
D13/199; D15/138, 199
CPC .. H05K 3/007; H05K 1/0393; H01L 51/0097;
H01L 21/683; H01L 21/67742; H01L
21/68707

See application file for complete search history.

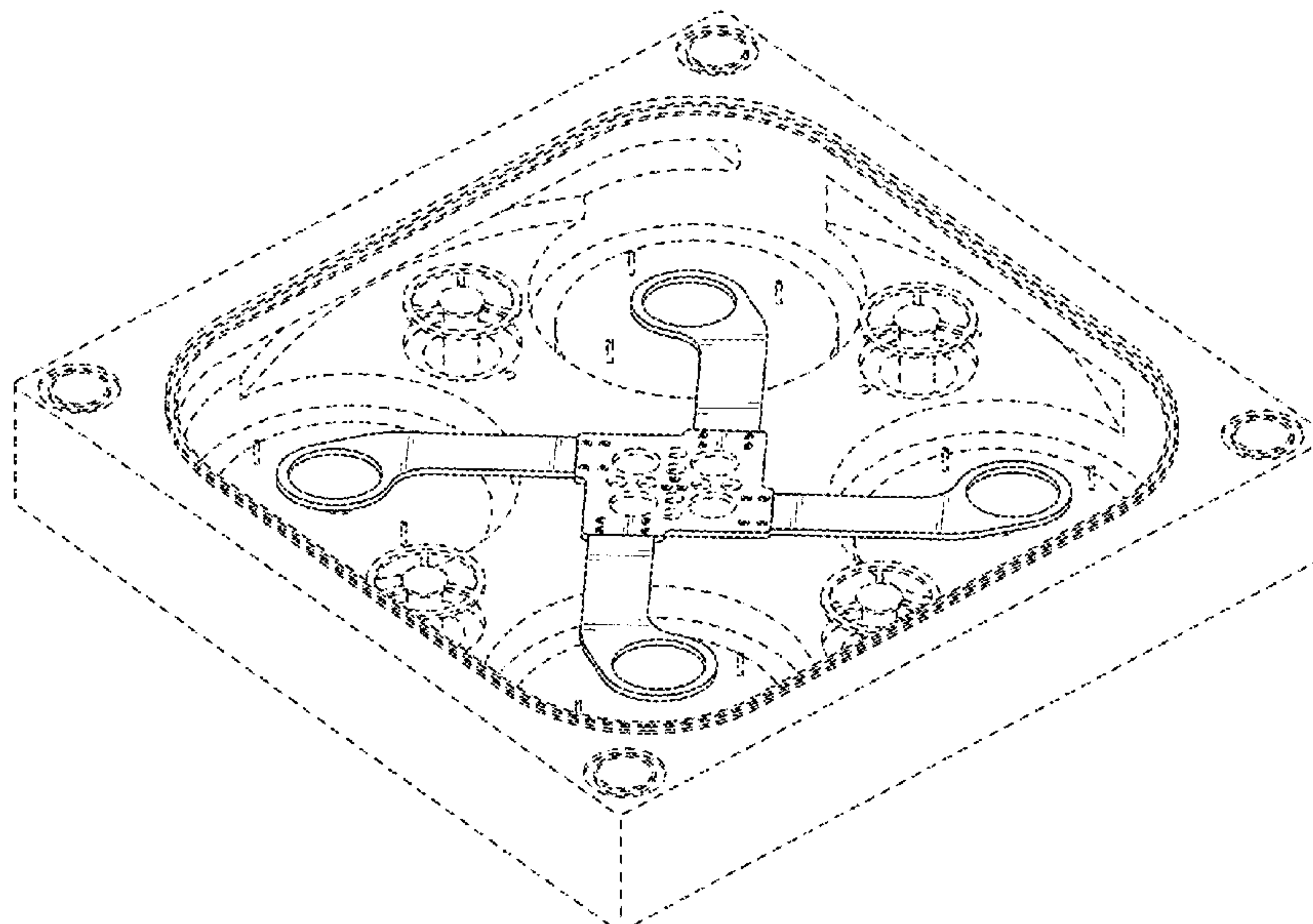
FIG. 1 is a top view of a substrate transfer structure showing our new design;

FIG. 2 is a top angled view of the substrate transfer structure; FIG. 3 is a perspective view of the substrate transfer structure;

FIG. 4 is a left side view of the substrate transfer structure, with the right side and back side views being identical images thereof; and,

FIG. 5 is a front side view of the substrate transfer structure. The broken lines are for the purpose of showing environmental structure, and form no part of the claimed design.

1 Claim, 5 Drawing Sheets



(56)

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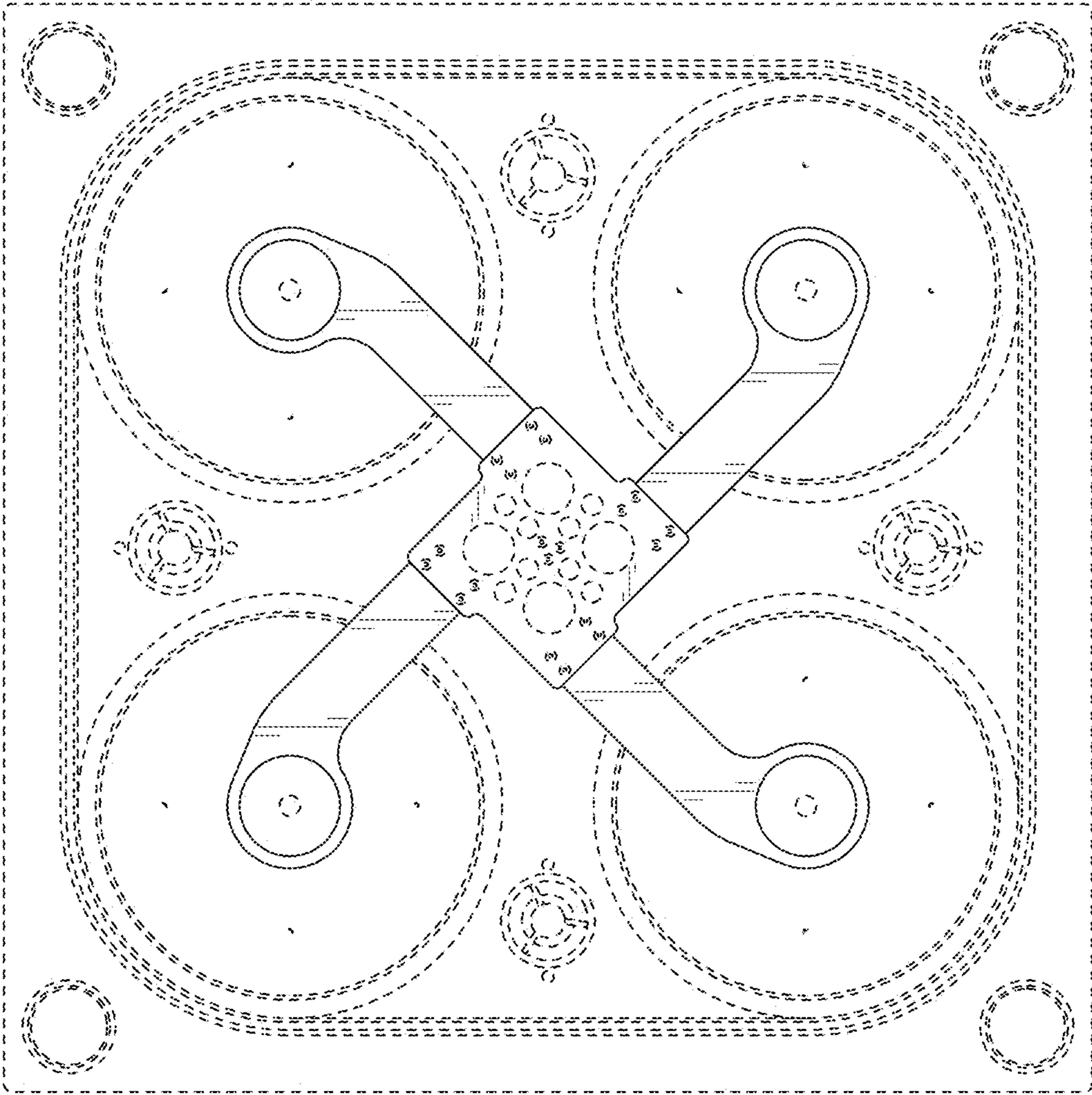


FIG. 1

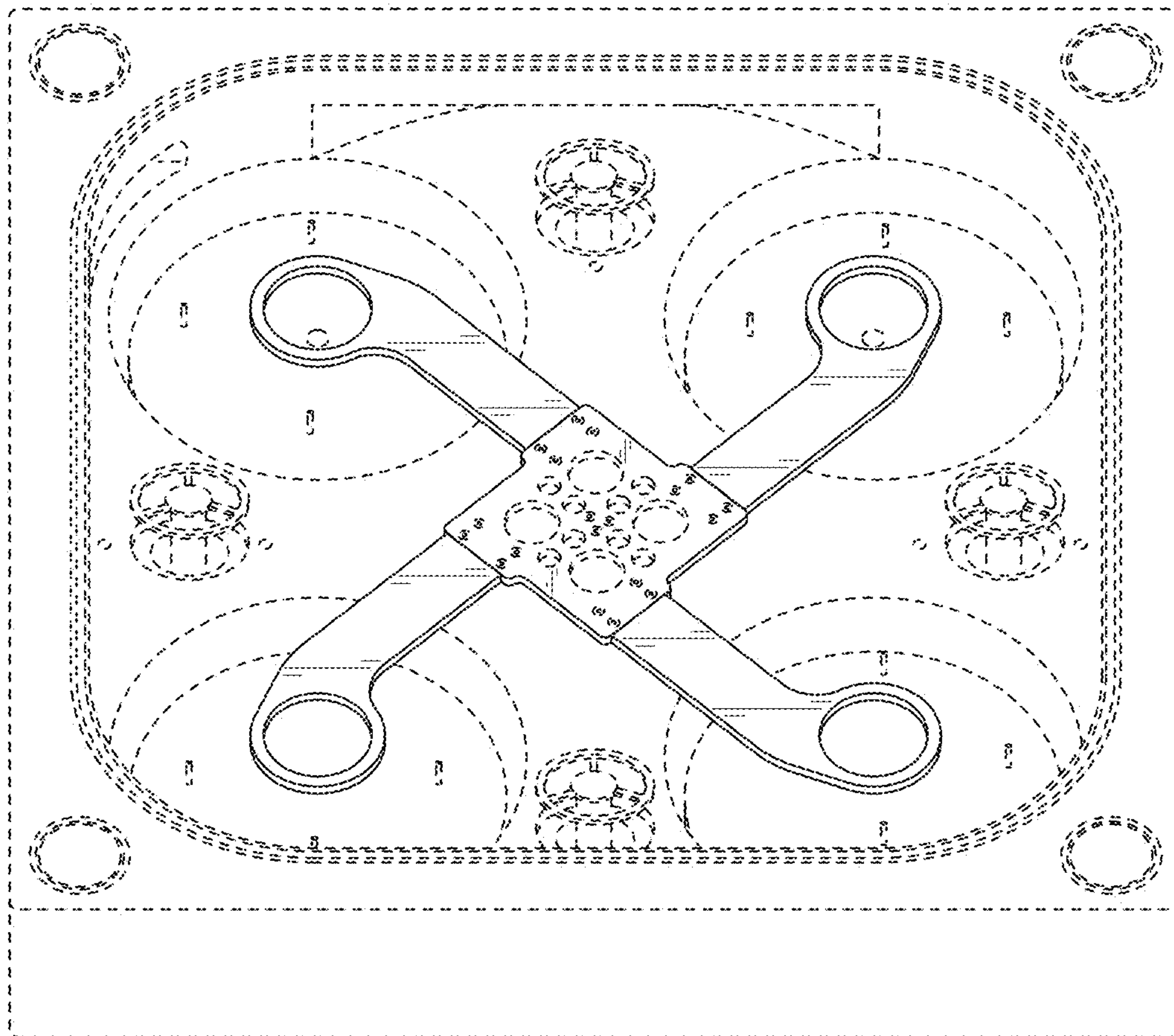


FIG. 2

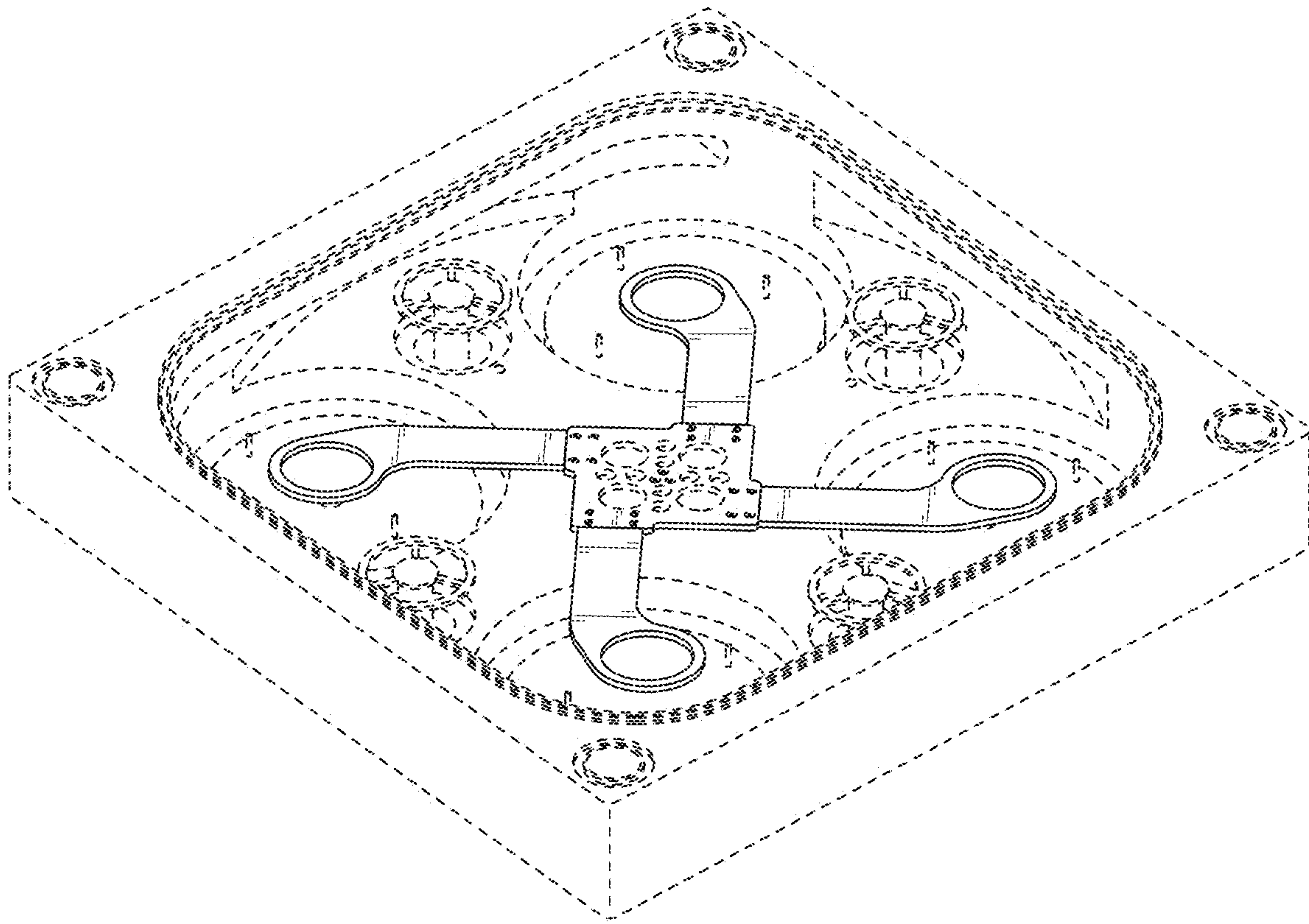


FIG. 3



FIG. 4

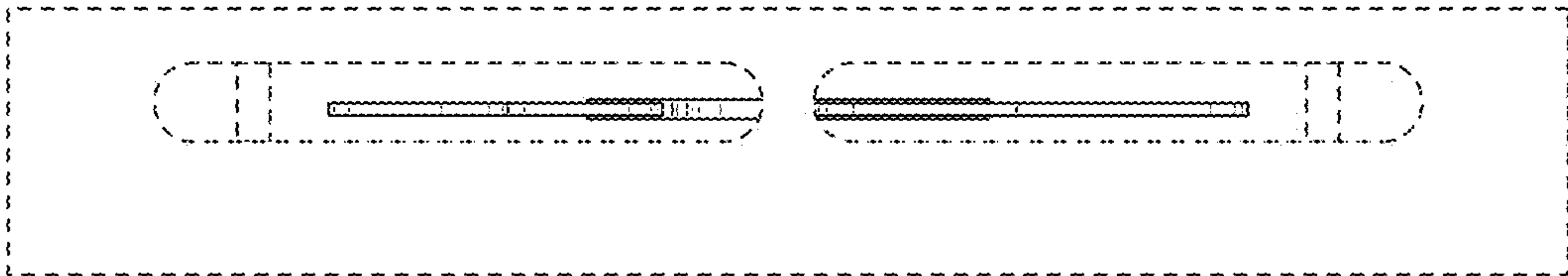


FIG. 5